

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Fang-Ming Huang	02/21/2011
Tsung-Chieh Chang	02/22/2011
RECEIVING PARTY DATA	
Name:	Himax Imaging, Inc.
Street Address:	Cricket Square, Hutchins Drive, P.O. Box 2681
City:	Grand Cayman
State/Country:	CAYMAN ISLANDS
Name:	Himax Semiconductor, Inc.
Street Address:	No.26, Zih Lian Road, Fonghua Village, Xinshi Dist.
City:	Tainan City
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13101148
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Total Attachments: 2 source=1111901#page1.tif source=1111901#page2.tif	

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PATENT
REEL: 026228 FRAME: 0031

ASSIGNMENT OF INVENTION

In consideration of the payment by ASSIGNEE to ASSIGNOR of the sum of One Dollar (\$1.00), the receipt of which is hereby acknowledged, and for other good and valuable consideration.

ASSIGNOR(S) (Inventors):

Name: Fang-Ming Huang Nationality: TW

Name: Tsung-Chieh Chang Nationality: TW

Hereby sells, assigns and transfers to

ASSIGNEE(S):

Name: Himax Imaging, Inc.

Address: Cricket Square, Hutchins Drive, P.O. Box 2681, Grand Cayman KYI-1111, Cayman Islands

Name: Himax Semiconductor, Inc.

Address: No.26, Zih Lian Road, Fonghua Village, Xinshi Dist., Tainan City 74148, Taiwan, R.O.C.

and the successors and assignees of the ASSIGNEE the entire right, title, and interest in and to any and all improvements which are disclosed in the invention entitled:

**"BACK-SIDE ILLUMINATION IMAGE SENSOR AND METHOD FOR FABRICATING
BACK-SIDE ILLUMINATION IMAGE SENSOR"**

Which is found in :

- (a) + U.S. patent application executed on even date
(b) _____ U.S. patent application executed on _____
(c) _____ U.S. application serial no. _____
(d) _____ patent no. _____ issued _____
(e) _____ International application no. _____

and, in and to, all Letters Patent to be obtained for said invention by the above application or any continuations, continuation-in-part, divisions, renewals, substitutes, or extensions thereof, and as to Letters Patent any reissue or re-examination thereof

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment;

ASSIGNOR further covenants that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said invention and said Letters Patent and legal equivalents as may be known and accessible to ASSIGNOR and will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to ASSIGNEE or its legal representatives any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce said application, said invention and said Letters Patent and said equivalents thereof which may be necessary or desirable to carry out the proposes thereof.

IN WITNESS WHEREOF, We have hereunto set hand and seal this _____ (Date of signing). (請發明人務必簽署上列日期。)

(Type name of inventor)

Fang-Ming Huang

Tsung-Chieh Chang

Signature of INVENTOR

Huang Fang Ming Feb. 22, 2011
Tsung-Chieh Chang Feb. 22, 2011